

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Feng Pan

Title: High Voltage Ripple Reduction and Substrate Protection

Application No.: 10/811,074 Filing Date: March 26, 2004

Examiner: Unassigned Group Art Unit: 2838

Docket No.: SNDK.307US1 Conf. No.: 8070

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Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**INFORMATION DISCLOSURE STATEMENT**

Dear Sir:

Pursuant to 37 C.F.R. §§ 1.56, 1.97 and 1.98, Applicant calls the documents listed on the enclosed Form PTO-1449 to the Examiner's attention in this patent application.

Citation of these documents shall not be construed as (1) an admission that the documents are prior art with respect to the invention or inventions claimed in this application, (2) a representation that a search has been made (other than as indicated by any cited document), or (3) an admission that the cited information is, or is considered to be, material to patentability as defined in § 1.56(b).

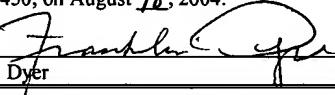
This application has a filing date after June 30, 2003. Copies of the U.S. Patent(s) and U.S. Published Patent Application(s) documents listed on the accompanying Form PTO-1449 are not enclosed.

This information disclosure statement is submitted under 37 C.F.R. § 1.97(b) and consequently no fee should be required. The Commissioner is authorized, however, to charge

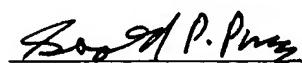
any fee that may be required, or to credit any overpayment, against Deposit Account No. 502664. This form is being submitted in duplicate.

Certificate of Mailing Under 37 CFR 1.8

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on August 10, 2004.

  
Franklin Dyer

Respectfully submitted,



Gerald P. Parsons  
Reg. No. 24,486

8/10/04  
Date

U.S. Department of Commerce, Patent and Trademark		Atty. Docket No.			Application No.		
INFORMATION DISCLOSURE STATEMENT BY APPLICANT		SNDK.307US1			10/811,074		
		Applicant(s)			Conf. No.		
(Use several sheets if necessary)		Feng Pan			8070		
		Filing Date			Group		
		March 26, 2004			2838		
<b>U.S. Patent Documents</b>							
*Examiner Initial		Document Number	Date	Name	Class	Subclass	Filing Date If Appropriate
	1	4,583,157	4/15/1986	Kirsch et al.			
	2	5,563,779	10/8/1996	Cave et al.			
	3	6,424,570	7/23/2002	Le et al.			
<b>U.S. Published Patent Application Documents</b>							
*Examiner Initial		Document Number	Date	Name	Class	Subclass	Filing Date If Appropriate
<b>Foreign Patent Documents</b>							
							Translation
		Document	Date	Country	Class	Subclass	Yes
	4	PCT/US03/39772	6/17/2003	WIPO			No
<b>OTHER ART (Including Author, Title, Date, Pertinent Pages, Etc.)</b>							
Examiner		Date Considered					
<p>*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with your communication to applicant.</p>							